



#### 100V N-CHANNEL ENHANCEMENT MODE MOSFET

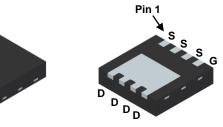
### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
100V	15mΩ @ V <sub>GS</sub> = 10V	34A
	19.5mΩ @ V <sub>GS</sub> = 6V	32A

# **Description and Applications**

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize  $R_{\text{DS(ON)}}$  and yet maintain superior switching performance. This device is ideal for use in Notebook battery power management and Load switch.

- Backlighting
- Power Management Functions
- DC-DC Converters



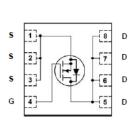
Top View Bottom View

## **Features and Benefits**

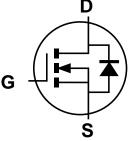
- 100% Unclamped Inductive Switch (UIS) Test in Production
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On State Losses
- Low Input Capacitance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: V-DFN3333-8 (Type B)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Below Diagram Terminals: Finish –NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.03 grams (Approximate)



Top View Internal Schematic



Equivalent Circuit

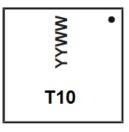
#### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMT10H015LCG-7	V-DFN3333-8 (Type B)	2,000/Tape & Reel
DMT10H015LCG-13	V-DFN3333-8 (Type B)	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



T10 = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 18 = 2018) WW = Week (01 to 53)



### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V <sub>DSS</sub>	100	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6)	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	9.4 7.5	А
Continuous Drain Current, V <sub>GS</sub> = 10V	Steady State	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I <sub>D</sub>	34 21	А
Maximum Continuous Body Diode Forward Curre	I <sub>S</sub>	1.6	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I <sub>DM</sub>	54	Α		
Avalanche Current, L = 3mH (Note 8)			I <sub>AS</sub>	7.5	Α
Avalanche Energy, L = 3mH (Note 8)			E <sub>AS</sub>	85	mJ

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P <sub>D</sub>	1	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	118	°C/W
Total Power Dissipation (Note 6)	P <sub>D</sub>	2.1	W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	59	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.5	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

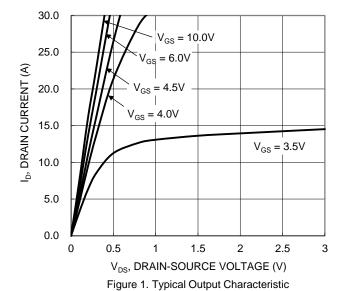
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	$BV_{DSS}$	100		_	V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.4	2	3.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
		1	12.1	15	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	1	15	19.5	11122	$V_{GS} = 6V, I_D = 20A$	
		_	18.9	26	mΩ	$V_{GS} = 4.5V, I_D = 5A$	
Diode Forward Voltage	$V_{SD}$	_	0.9	1.3	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	1871	_		\/ 50\/ \/ 0\/	
Output Capacitance	Coss	1	261	_	pF	$V_{DS} = 50V$ , $V_{GS} = 0V$ f = 1MHz	
Reverse Transfer Capacitance	Crss	_	6.9	_			
Gate Resistance	Rg	_	0.75	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	$Q_g$	_	33.3	_		V 50V L 40A	
Gate-Source Charge	Qgs	_	6.9	_	nC	$V_{DD} = 50V, I_D = 10A,$ $V_{GS} = 10V$	
Gate-Drain Charge	$Q_{gd}$	_	5.1	_		VGS = 10V	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	6.5	_			
Turn-On Rise Time	t <sub>R</sub>	_	7	_		$V_{DD} = 50V, V_{GS} = 10V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	19.7	_	ns	$I_D = 10A$ , $R_g = 6\Omega$	
Turn-Off Fall Time	t <sub>F</sub>	_	8.1	_			
Reverse Recovery Time	t <sub>RR</sub>	1	37.9	_	ns		
Reverse Recovery Charge	Q <sub>RR</sub>	_	51.9	_	nC	I <sub>F</sub> = 10A, di/dt = 100A/μs	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.





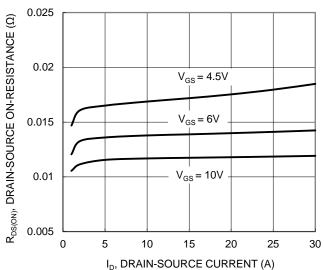
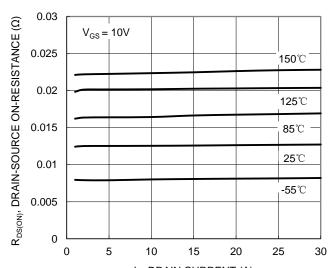
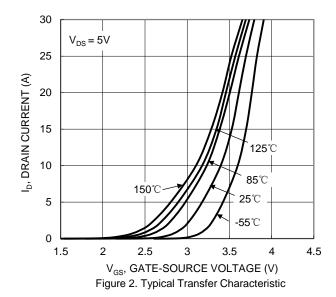
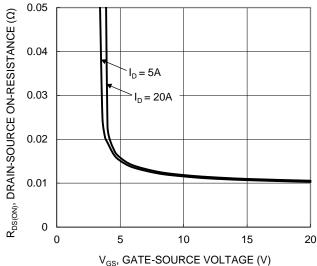


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage



I<sub>D</sub>, DRAIN CURRENT (A)Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





V<sub>GS</sub>, GATE-SOURCE VOLTAGE (V)
Figure 4. Typical Transfer Characteristic

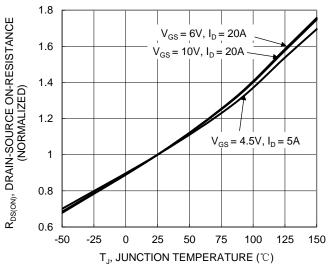


Figure 6. On-Resistance Variation with Junction Temperature



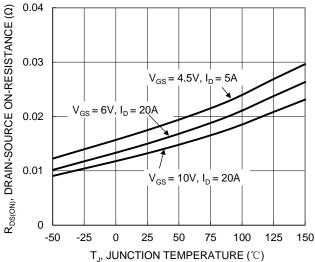
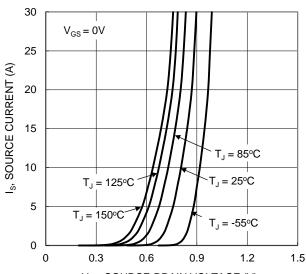
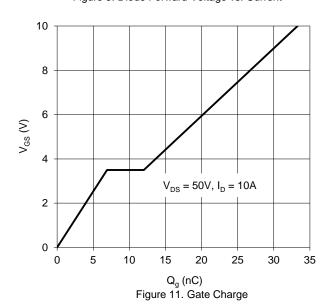


Figure 7. On-Resistance Variation with Junction
Temperature



V<sub>SD</sub>, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current



2.8 V<sub>GS(TH)</sub>, GATE THRESHOLD VOLTAGE (V) 2.6 2.4  $I_D = 1mA$ 2.2 2 1.8  $I_{D} = 250 \mu A$ 1.6 1.4 1.2 1 8.0 125 -50 -25 25 50 75 100 150

 $\rm T_{J}, \, JUNCTION \, TEMPERATURE \, (^{\circ}C)$  Figure 8. Gate Threshold Variation vs. Junction Temperature

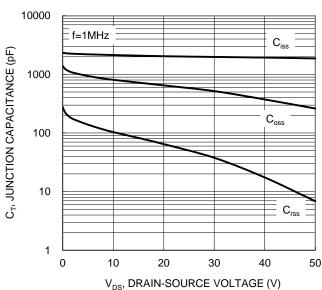


Figure 10. Typical Junction Capacitance

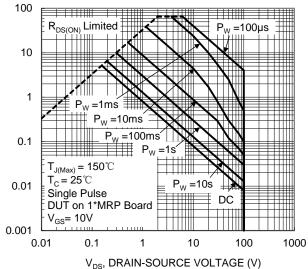


Figure 12. SOA, Safe Operation Area

ID, DRAIN CURRENT (A)



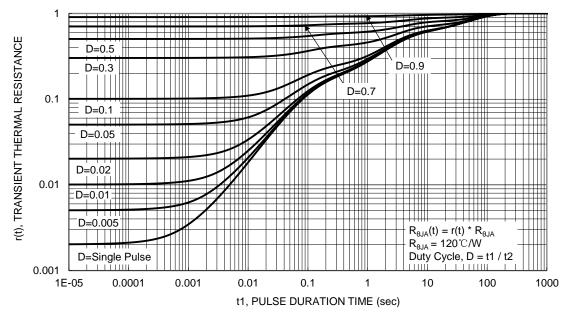
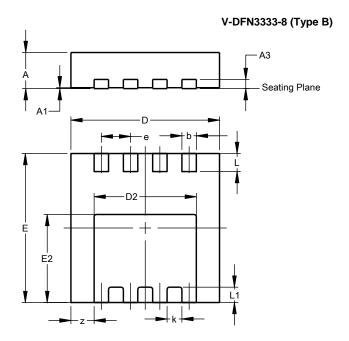


Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

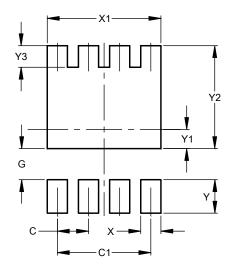


V-DFN3333-8						
(Type B)						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
A3			0.203			
b	0.27	0.37	0.32			
D	3.25	3.35	3.30			
D2	2.17	2.37	2.27			
Е	3.25	3.35	3.30			
E2	1.85	2.05	1.95			
е			0.65			
k	-		0.33			
L	0.35	0.45	0.40			
L1	-		0.34			
Z	-		0.515			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## V-DFN3333-8 (Type B)



Dimensions	Value (in mm)		
C	0.650		
C1	1.950		
G	0.650		
X	0.420		
X1	2.370		
Υ	0.700		
Y1	0.400		
Y2	2.150		
Y3	0.450		



#### **IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
  - 1. are intended to implant into the body, or
  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2018, Diodes Incorporated

www.diodes.com